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March 2015

FDMS5672
N-Channel UltraFET Trench® MOSFET
60V, 22A, 11.5mΩ

Features

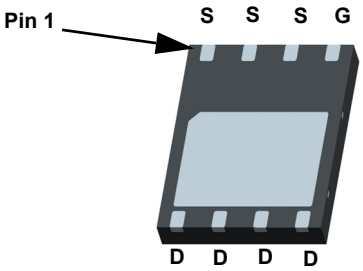
- Max $r_{DS(on)}$ = 11.5mΩ at V_{GS} = 10V, I_D = 10.6A
- Max $r_{DS(on)}$ = 16.5mΩ at V_{GS} = 6V, I_D = 8A
- Typ Qg = 32nC at V_{GS} = 10V
- Low Miller Charge
- Optimized Efficiency at High Frequencies
- RoHS Compliant

General Description

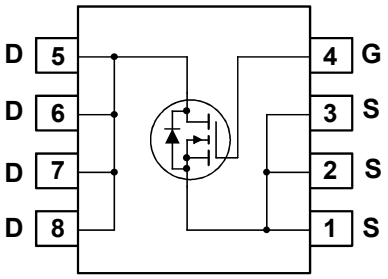
UltraFET devices combine characteristics that enable benchmark efficiency in power conversion applications. Optimized for $r_{DS(on)}$, low ESR, low total and Miller gate charge, these devices are ideal for high frequency DC to DC converters.

Application

- DC - DC Conversion



Power 56 (Bottom view)



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted.

Symbol	Parameter			Ratings	Units
V_{DS}	Drain to Source Voltage			60	V
V_{GS}	Gate to Source Voltage			±20	V
I_D	Drain Current -Continuous	T_C = 25°C	(Note 5)	65	A
	-Continuous	T_C = 100°C	(Note 5)	39	
	-Continuous	T_A = 25°C	(Note 1a)	10.6	
	-Pulsed		(Note 4)	176	
E_{AS}	Single Pulse Avalanche Energy		(Note 3)	337	mJ
P_D	Power Dissipation	T_C = 25°C		78	W
	Power Dissipation	T_A = 25°C	(Note 1a)	2.5	
T_J, T_{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS5672	FDMS5672	Power 56	13”	12mm	3000 units

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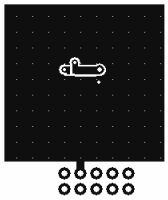
Electrical Characteristics T_J = 25°C unless otherwise noted.

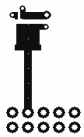
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250μA, V_{GS} = 0V	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250μA, referenced to 25°C		59		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 48V, V_{GS} = 0V			1	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
On Characteristics						
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	2	3.2	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250μA, referenced to 25°C		-11		mV/°C
$r_{DS(on)}$	Drain to Source On Resistance	V_{GS} = 10V, I_D = 10.6A		9.4	11.5	mΩ
		V_{GS} = 6V, I_D = 8A		13.0	16.5	
		V_{GS} = 10V, I_D = 10.6A, T_J = 125°C		15.0	18.0	
g_{FS}	Forward Transconductance	V_{DS} = 10V, I_D = 10.6A		26		S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 30V, V_{GS} = 0V, f = 1MHz		2100	2800	pF
C_{oss}	Output Capacitance			375	500	pF
C_{rss}	Reverse Transfer Capacitance			120	180	pF
R_g	Gate Resistance	f = 1MHz		1.2		Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 30V, I_D = 10.6A, V_{GS} = 10V, R_{GEN} = 6Ω		16	29	ns
t_r	Rise Time			17	31	ns
$t_{d(off)}$	Turn-Off Delay Time			22	35	ns
t_f	Fall Time			8	16	ns
$Q_{g(TOT)}$	Total Gate Charge at 10V	V_{GS} = 0V to 10V; V_{DD} = 30V, I_D = 10.6A		32	45	nC
Q_{gs}	Gate to Source Gate Charge			10		nC
Q_{gd}	Gate to Drain "Miller" Charge			8.3		nC
Drain-Source Diode Characteristics						
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0V, I_S = 10.6A (Note 2)		0.80	1.20	V
t_{rr}	Reverse Recovery Time	I_F = 10.6A, di/dt = 100A/μs		35	53	ns
Q_{rr}	Reverse Recovery Charge			42	63	nC

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1in^2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 50°C/W when mounted on a 1 in^2 pad of 2 oz copper



b. 125°C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300μs, Duty cycle < 2.0%.
3. Starting T_J = 25°C, L = 3mH, I_{AS} = 15A, V_{DD} = 60V, V_{GS} = 10V.
4. Pulsed Id please refer to Fig 11 SOA graph for more details.
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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Typical Characteristics T_J = 25°C unless otherwise noted.

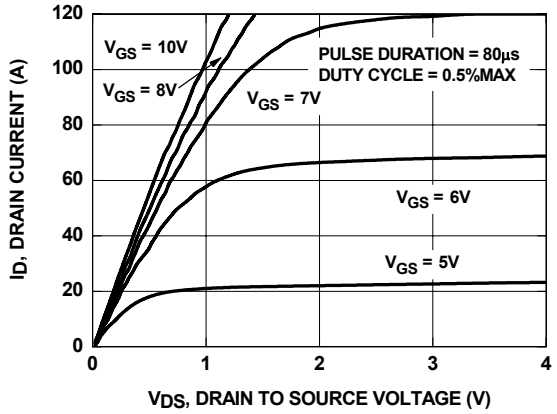

Figure 1. On Region Characteristics

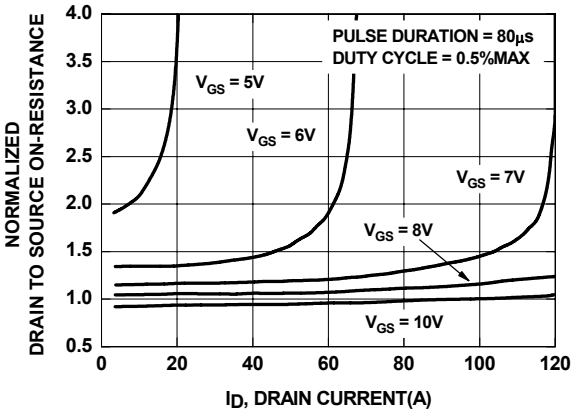

Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

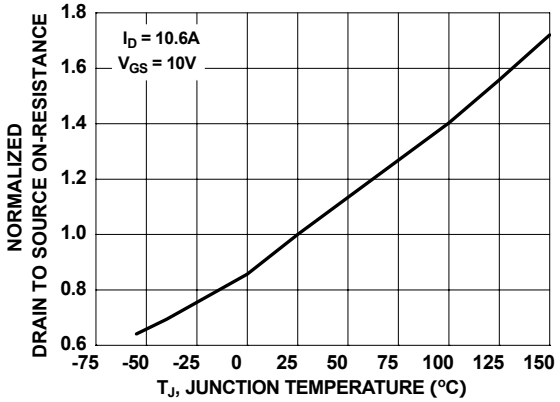

Figure 3. Normalized On Resistance vs. Junction Temperature

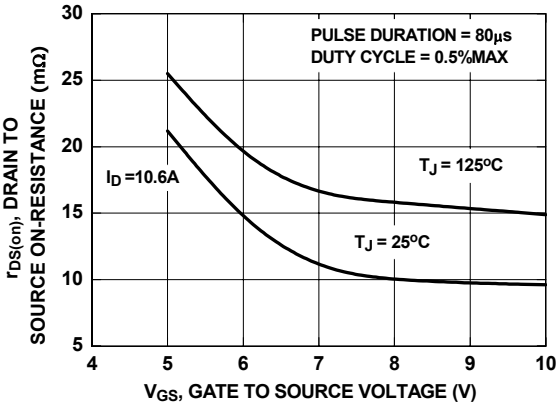

Figure 4. On-Resistance vs. Gate to Source Voltage

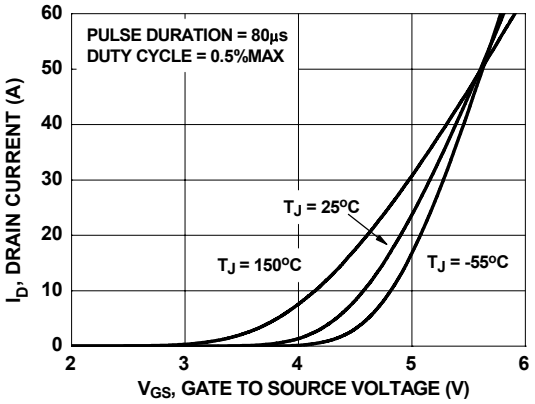

Figure 5. Transfer Characteristics

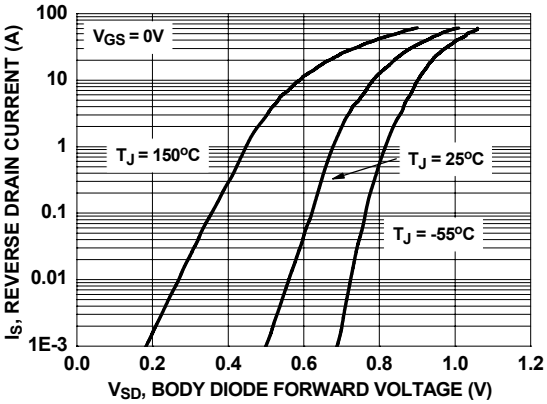

Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

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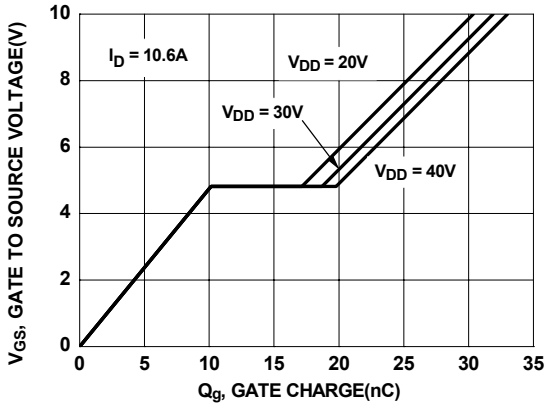

Figure 7. Gate Charge Characteristics

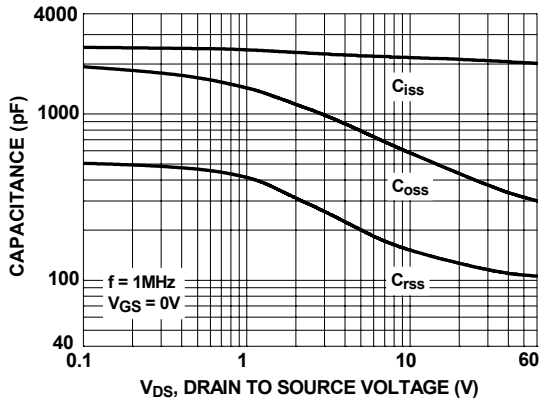

Figure 8. Capacitance vs. Drain to Source Voltage

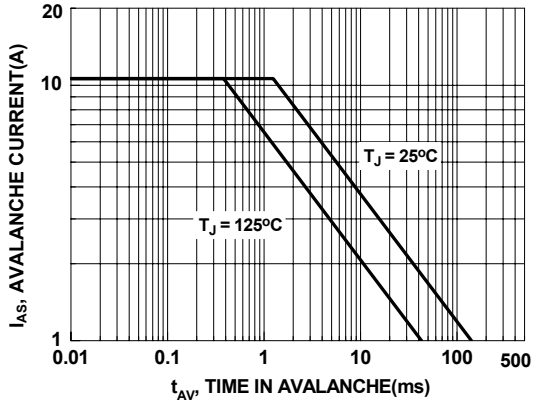

Figure 9. Unclamped Inductive Switching Capability

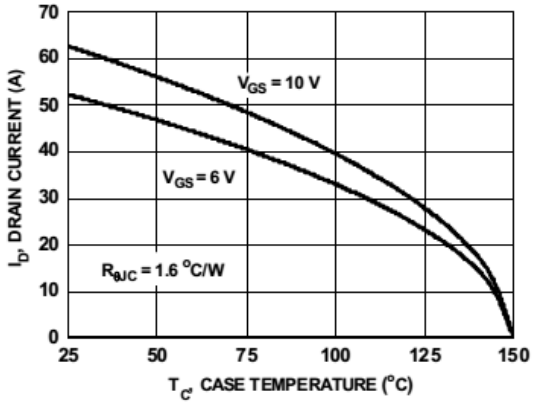

Figure 10. Maximum Continuous Drain Current vs. Case Temperature

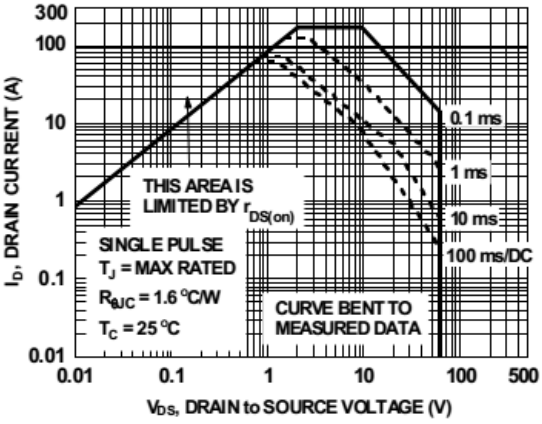

Figure 11. Forward Bias Safe Operating Area

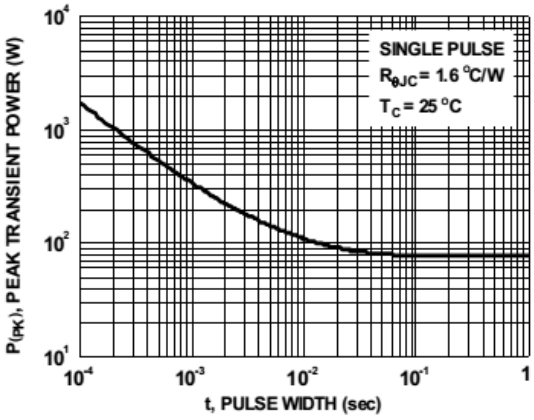

Figure 12. Single Pulse Maximum Power Dissipation

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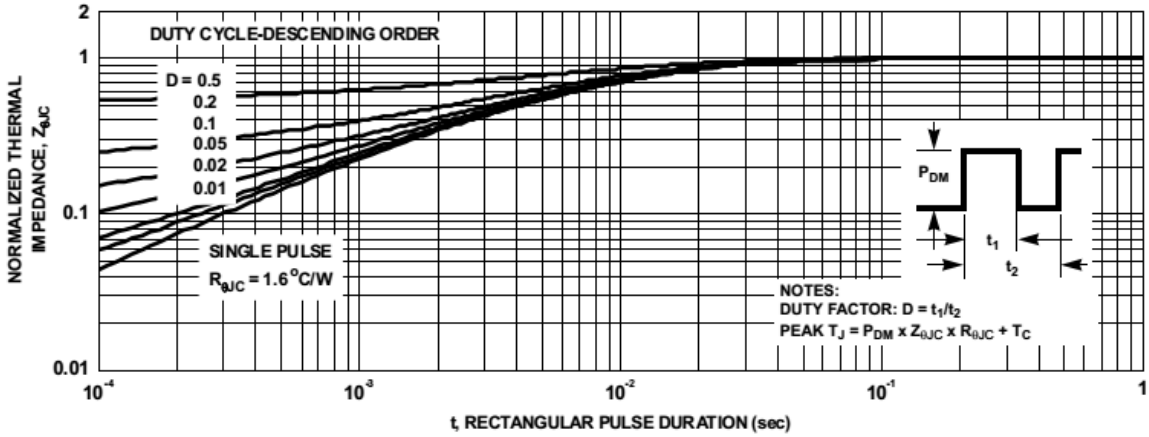

Figure 13. Transient Thermal Response Curve

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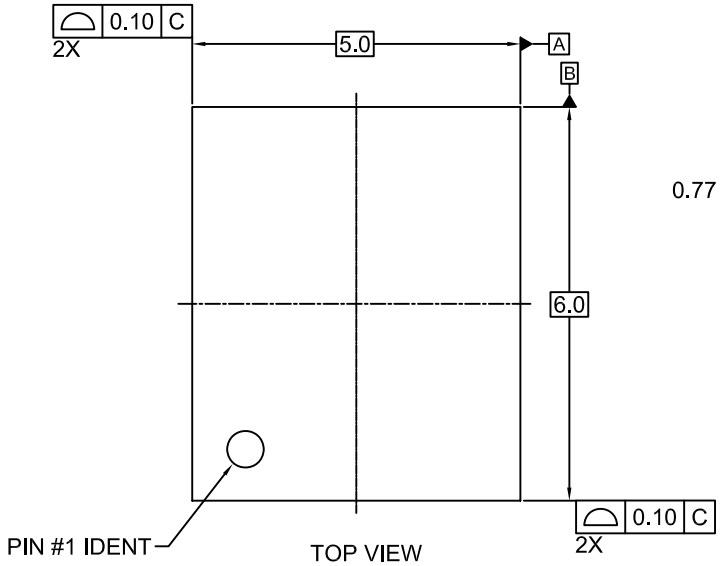
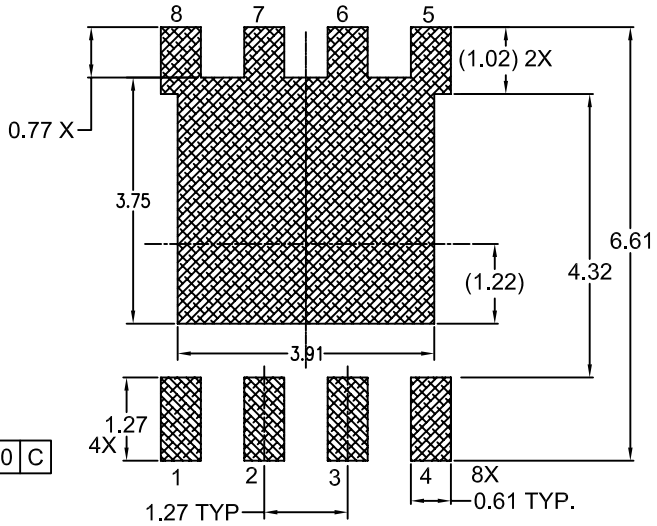
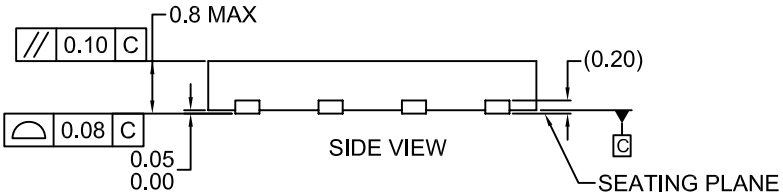
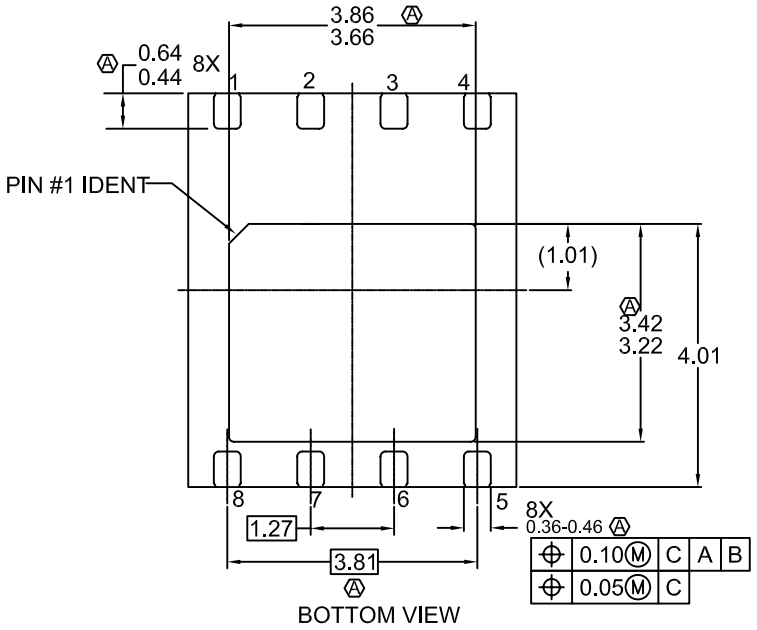
REVISIONS			
NBR	DESCRIPTION	DATE	NAME/SITE
1	RELEASE TO DOCUMENT CONTROL	090305	David/FSPM
2	REVISE TO CORRECT DAP SIZE	080605	David/FSPM
3	I) REVISE TO CORRECT PKG THK II) REVISE THE PKG PROFILE TOLERANCE	210306	CK/FSPM
4	ADD IN LEAD LENGTH FOR LAND PATTERN	220908	LY/FSPM





RECOMMENDED LAND PATTERN





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FAIRCHILD SEMICONDUCTOR™

8LD, MLP, DUAL, NON-JEDEC, 5X6 MM BODY, TIED DAP

PROJECTION

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